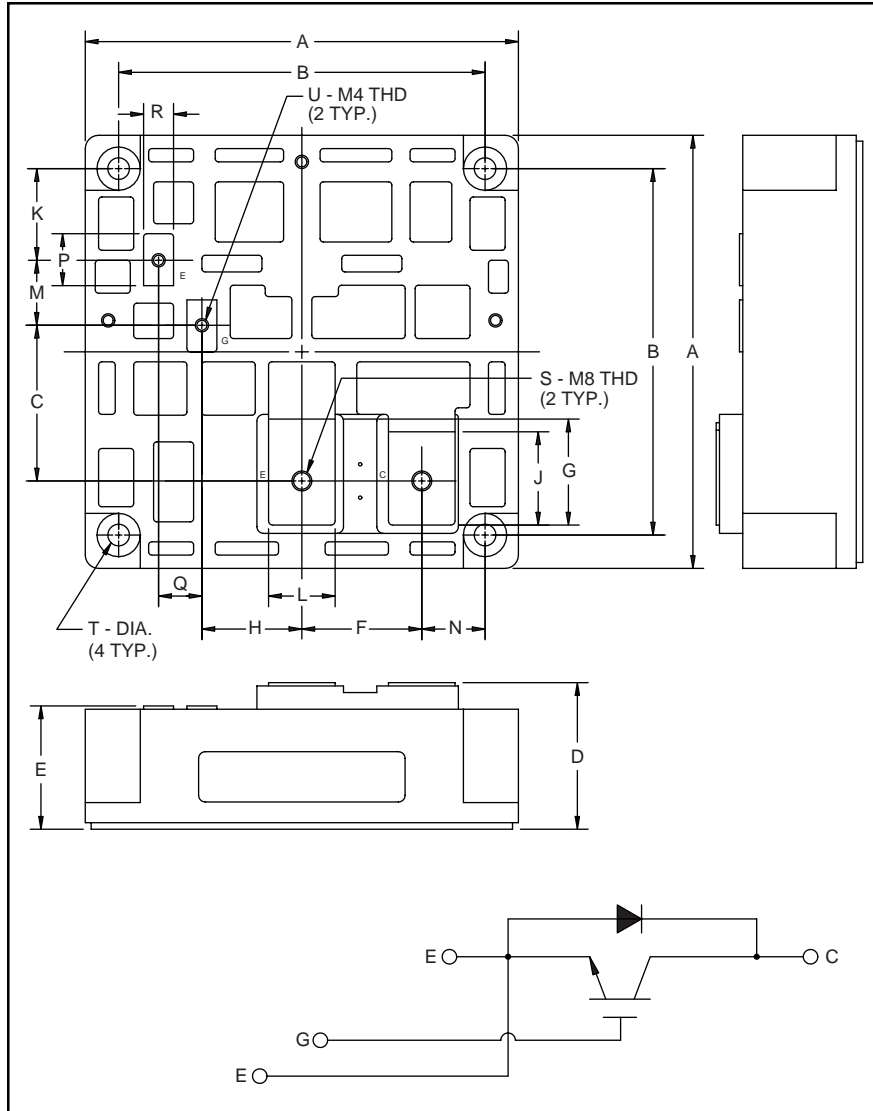


Single IGBTMOD™ H-Series Module 800 Amperes/1400 Volts



Outline Drawing and Circuit Diagram

Dimensions	Inches	Millimeters
A	5.12	130.0
B	4.33±0.01	110.0±0.25
C	1.840	46.75
D	1.73±0.04/0.02	44.0±1.0/0.5
E	1.46±0.04/0.02	37.0±1.0/0.5
F	1.42	36.0
G	1.25	31.8
H	1.18	30.0
J	1.10	28.0
K	1.08	27.5

Dimensions	Inches	Millimeters
L	0.79	20.0
M	0.77	19.5
N	0.75	19.0
P	0.61	15.6
Q	0.51	13.0
R	0.35	9.0
S	M8 Metric	M8
T	0.26 Dia.	Dia. 6.5
U	M4 Metric	M4



Description:

Powerex IGBTMOD™ Modules are designed for use in switching applications. Each module consists of one IGBT Transistor in a single configuration with a reverse-connected super-fast recovery free-wheel diode. All components and interconnects are isolated from the heat sinking baseplate, offering simplified system assembly and thermal management.

Features:

- ☐ Low Drive Power
- ☐ Low $V_{CE(sat)}$
- ☐ Discrete Super-Fast Recovery (135ns) Free-Wheel Diode
- ☐ High Frequency Operation (20-25kHz)
- ☐ Isolated Baseplate for Easy Heat Sinking

Applications:

- ☐ AC Motor Control
- ☐ Motion/Servo Control
- ☐ UPS
- ☐ Welding Power Supplies
- ☐ Laser Power Supplies

Ordering Information:

Example: Select the complete part module number you desire from the table below -i.e. CM800HA-28H is a 1400V (V_{CES}), 800 Ampere Single IGBTMOD™ Power Module.

Type	Current Rating Amperes	V_{CES} Volts (x 50)
CM	800	28



Powerex, Inc., 200 Hillis Street, Youngwood, Pennsylvania 15697-1800 (724) 925-7272

CM800HA-28H
Single IGBTMOD™ H-Series Module
800 Amperes/1400 Volts

Absolute Maximum Ratings, $T_j = 25^\circ\text{C}$ unless otherwise specified

Ratings	Symbol	CM800HA-28H	Units
Junction Temperature	T_j	-40 to +150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-40 to +125	$^\circ\text{C}$
Collector-Emitter Voltage (G-E SHORT)	V_{CES}	1400	Volts
Gate-Emitter Voltage	V_{GES}	± 20	Volts
Collector Current	I_C	800	Amperes
Peak Collector Current	I_{CM}	1600*	Amperes
Diode Forward Current	I_F	800	Amperes
Diode Forward Surge Current	I_{FM}	1600*	Amperes
Power Dissipation	P_d	4800	Watts
Max. Mounting Torque M8 Terminal Screws	—	95	in-lb
Max. Mounting Torque M6 Mounting Screws	—	26	in-lb
Max. Mounting Torque M4 G-E Terminal Screws	—	13	in-lb
Module Weight (Typical)	—	1600	Grams
V Isolation	V_{RMS}	2500	Volts

* Pulse width and repetition rate should be such that device junction temperature does not exceed the device rating.

Static Electrical Characteristics, $T_j = 25^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Collector-Cutoff Current	I_{CES}	$V_{\text{CE}} = V_{\text{CES}}, V_{\text{GE}} = 0\text{V}$	—	—	5.0	mA
Gate Leakage Current	I_{GES}	$V_{\text{GE}} = V_{\text{GES}}, V_{\text{CE}} = 0\text{V}$	—	—	0.5	μA
Gate-Emitter Threshold Voltage	$V_{\text{GE(th)}}$	$I_C = 80\text{mA}, V_{\text{CE}} = 10\text{V}$	4.5	6.0	7.5	Volts
Collector-Emitter Saturation Voltage	$V_{\text{CE(sat)}}$	$I_C = 800\text{A}, V_{\text{GE}} = 15\text{V}$	—	2.7	3.6	Volts
		$I_C = 800\text{A}, V_{\text{GE}} = 15\text{V}, T_j = 150^\circ\text{C}$	—	2.4	—	Volts
Total Gate Charge	Q_G	$V_{\text{CC}} = 600\text{V}, I_C = 800\text{A}, V_{\text{GS}} = 15\text{V}$	—	4590	—	nC
Diode Forward Voltage	V_{FM}	$I_E = 800\text{A}, V_{\text{GS}} = 0\text{V}$	—	—	3.5	Volts

* Pulse width and repetition rate should be such that device junction temperature rise is negligible.

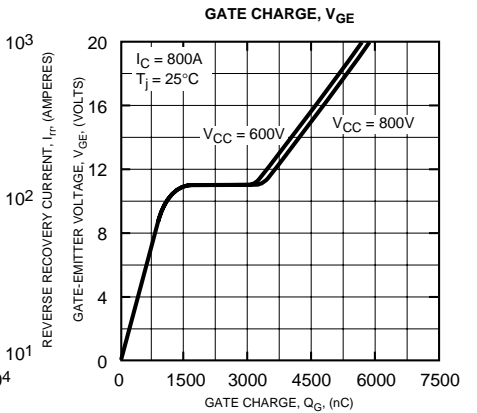
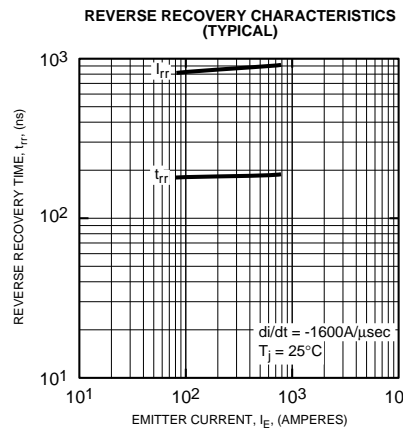
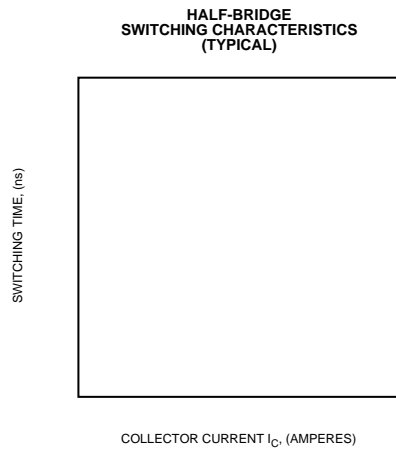
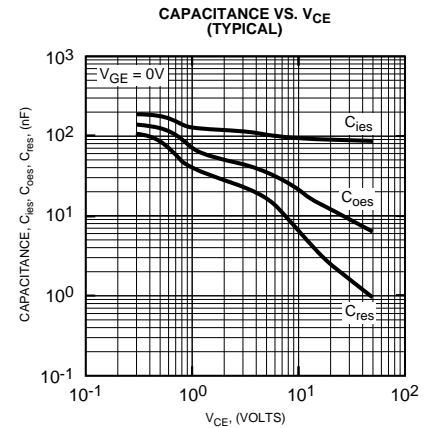
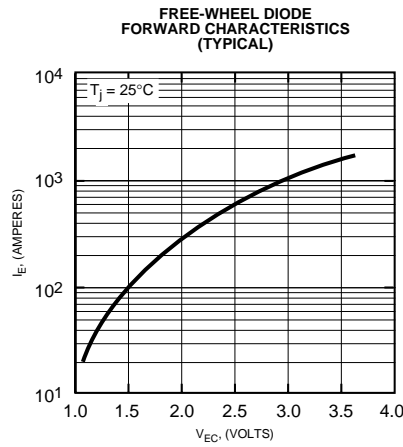
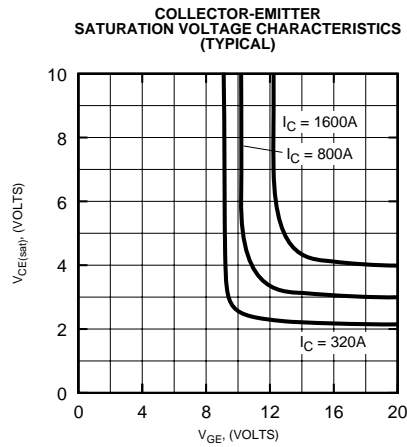
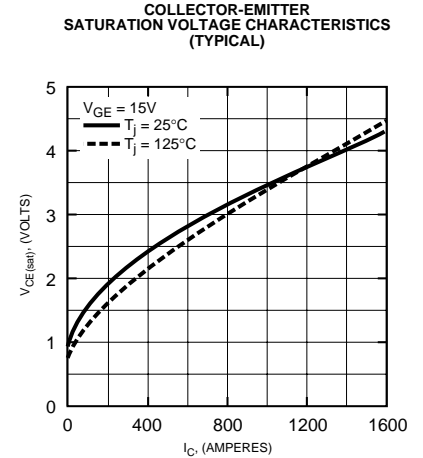
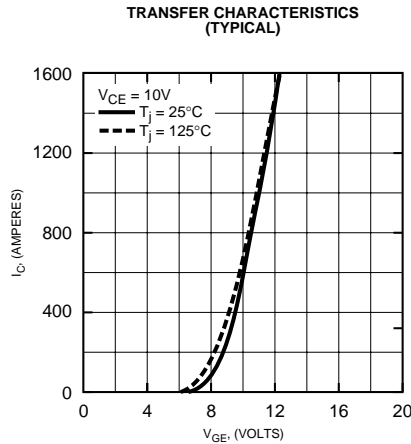
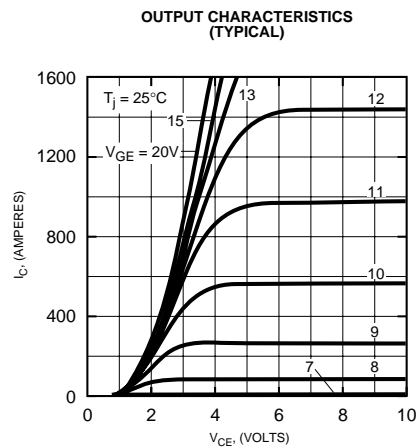
Dynamic Electrical Characteristics, $T_j = 25^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Input Capacitance	C_{ies}	$V_{\text{GE}} = 0\text{V}, V_{\text{CE}} = 10\text{V}, f = 1\text{MHz}$	—	—	172	nF
Output Capacitance	C_{oes}		—	—	60	nF
Reverse Transfer Capacitance	C_{res}		—	—	35	nF
Resistive	Turn-on Delay Time	$V_{\text{CC}} = 600\text{V}, I_C = 800\text{A}, V_{\text{GE1}} = V_{\text{GE2}} = 15\text{V}, R_G = 3.3\Omega$	—	—	500	ns
Load	Rise Time		—	—	1200	ns
Switching	Turn-off Delay Time		—	—	1000	ns
Times	Fall Time		—	—	350	ns
Diode Reverse Recovery Time	t_{rr}	$I_E = 800\text{A}, di_E/dt = -1600\text{A}/\mu\text{s}$	—	—	250	ns
Diode Reverse Recovery Charge	Q_{rr}	$I_E = 800\text{A}, di_E/dt = -1600\text{A}/\mu\text{s}$	—	6.3	—	μC

Thermal and Mechanical Characteristics, $T_j = 25^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal Resistance, Junction to Case	$R_{\text{th(j-c)}}$	Per IGBT	—	—	0.026	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction to Case	$R_{\text{th(j-c)}}$	Per FWDi	—	—	0.058	$^\circ\text{C}/\text{W}$
Contact Thermal Resistance	$R_{\text{th(c-f)}}$	Per Module, Thermal Grease Applied	—	—	0.018	$^\circ\text{C}/\text{W}$

CM800HA-28H
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